

## IGBT (NPT) Module

$$V_{CES} = 1200V$$

$$I_{C25} = 90A$$

$$V_{CE(sat)} = 2.2V$$


Boost Chopper + free wheeling Diode

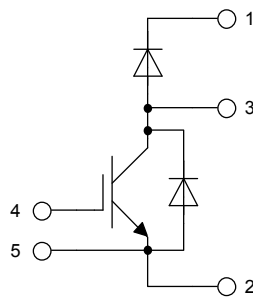
Part number

MID75-12A3



Backside: isolated

 E72873



### Features / Advantages:

- NPT IGBT technology
- low saturation voltage
- low switching losses
- switching frequency up to 30 kHz
- square RBSOA, no latch up
- high short circuit capability
- positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- ultra fast free wheeling diodes

### Applications:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

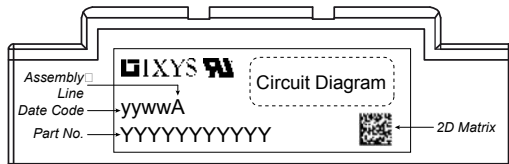
### Package: Y4

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Free Wheeling Diode FWD				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
$V_{RSM}$	max. non-repetitive reverse blocking voltage				1200	V	
$V_{RRM}$	max. repetitive reverse blocking voltage				1200	V	
$I_R$	reverse current, drain current	$V_R = 1200\text{ V}$			650	$\mu\text{A}$	
		$V_R = 1200\text{ V}$			2	mA	
$V_F$	forward voltage drop	$I_F = 50\text{ A}$			2.50	V	
		$I_F = 100\text{ A}$			3.00	V	
		$I_F = 50\text{ A}$	$T_{VJ} = 125^\circ\text{C}$			1.90	V
		$I_F = 100\text{ A}$	$T_{VJ} = 125^\circ\text{C}$			2.30	V
$I_{FAV}$	average forward current	$T_C = 80^\circ\text{C}$	$T_{VJ} = 150^\circ\text{C}$		60	A	
		DC current	$d = 1$				
$V_{FO}$	threshold voltage	} for power loss calculation only	$T_{VJ} = 150^\circ\text{C}$		1.30	V	
$r_F$	slope resistance				12	m $\Omega$	
$R_{thJC}$	thermal resistance junction to case				0.66	K/W	
$R_{thCH}$	thermal resistance case to heatsink			0.66		K/W	
$P_{tot}$	total power dissipation		$T_C = 25^\circ\text{C}$		190	W	
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}; V_R = 0\text{ V}$	$T_{VJ} = 45^\circ\text{C}$		400	A	
$C_J$	junction capacitance	$V_R = 600\text{ V}$ $f = 1\text{ MHz}$	$T_{VJ} = 25^\circ\text{C}$		30	pF	

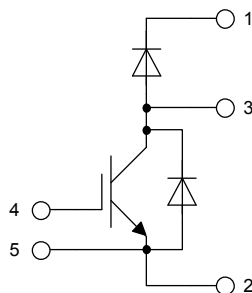
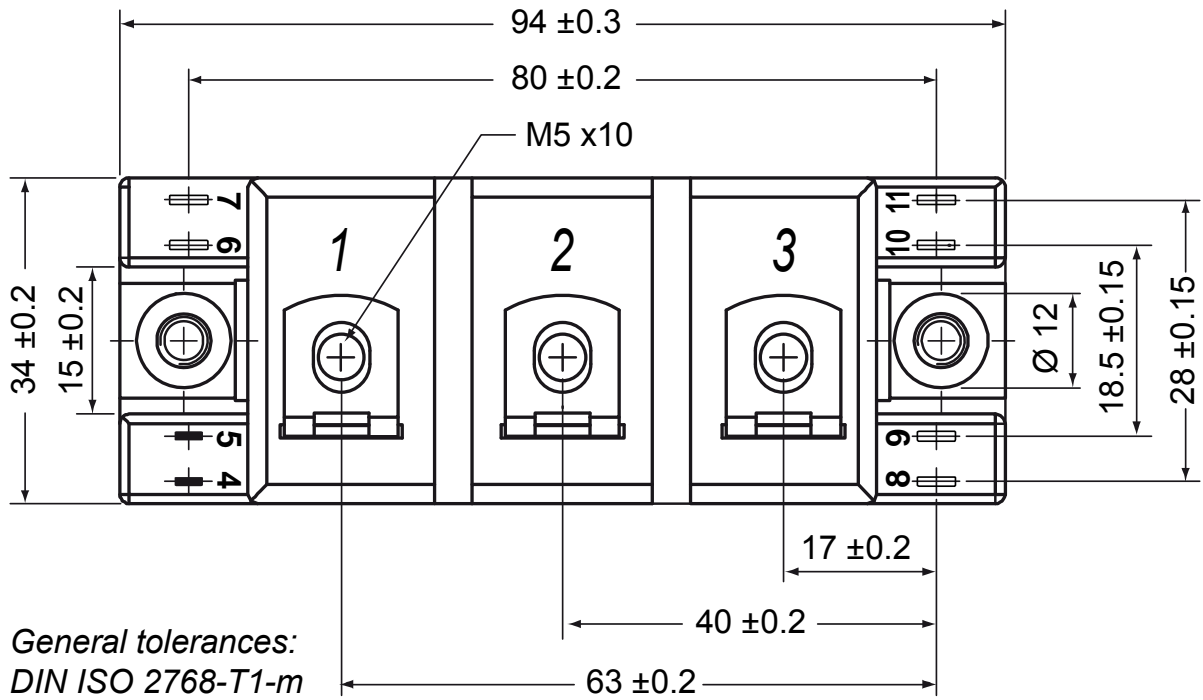
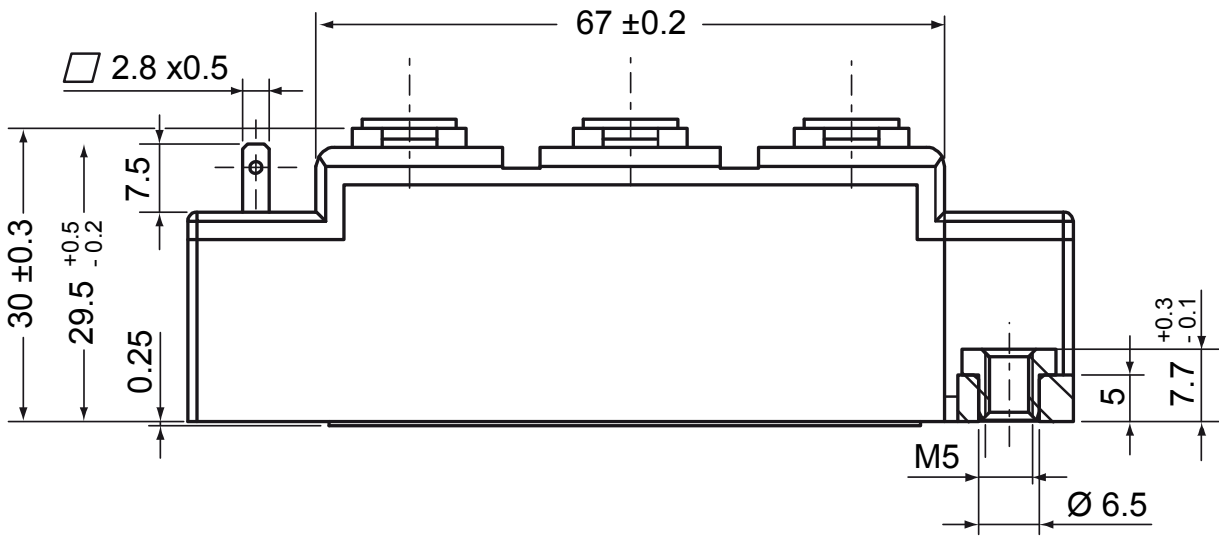
Boost IGBT				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^{\circ}\text{C}$			1200	V	
$V_{GES}$	max. DC gate voltage				$\pm 20$	V	
$V_{GEM}$	max. transient gate emitter voltage				$\pm 30$	V	
$I_{C25}$	collector current	$T_C = 25^{\circ}\text{C}$			90	A	
$I_{C80}$		$T_C = 80^{\circ}\text{C}$			60	A	
$P_{tot}$	total power dissipation	$T_C = 25^{\circ}\text{C}$			370	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 50\text{A}; V_{GE} = 15\text{V}$			2.2	V	
					2.7	V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 2\text{mA}; V_{GE} = V_{CE}$	4.5	5.5	6.5	V	
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{V}$			4	mA	
					6	mA	
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20\text{V}$			200	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600\text{V}; V_{GE} = 15\text{V}; I_C = 50\text{A}$		240		nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600\text{V}; I_C = 50\text{A}$ $V_{GE} = \pm 15\text{V}; R_G = 22\Omega$		100		ns	
$t_r$	current rise time			70		ns	
$t_{d(off)}$	turn-off delay time			500		ns	
$t_f$	current fall time			70		ns	
$E_{on}$	turn-on energy per pulse			7.6		mJ	
$E_{off}$	turn-off energy per pulse			5.6		mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15\text{V}; R_G = 22\Omega$					
$I_{CM}$		$V_{CEmax} = 1200\text{V}$			100	A	
<b>SCSOA</b>	short circuit safe operating area	$V_{CEmax} = 1200\text{V}$					
$t_{sc}$	short circuit duration	$V_{CE} = 1200\text{V}; V_{GE} = \pm 15\text{V}$			10	$\mu\text{s}$	
$I_{sc}$	short circuit current	$R_G = 22\Omega$ ; non-repetitive		180		A	
$R_{thJC}$	thermal resistance junction to case				0.33	K/W	
$R_{thCH}$	thermal resistance case to heatsink				0.33	K/W	
<b>Boost Diode BD</b>							
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^{\circ}\text{C}$			1200	V	
$I_{F25}$	forward current	$T_C = 25^{\circ}\text{C}$			100	A	
$I_{F80}$		$T_C = 80^{\circ}\text{C}$			60	A	
$V_F$	forward voltage	$I_F = 50\text{A}$			2.50	V	
				1.80		V	
$I_R$	reverse current	$V_R = V_{RRM}$			0.65	mA	
				1		mA	
$Q_{rr}$	reverse recovery charge	$V_R = 600\text{V}$ $-di_F/dt = 400\text{A}/\mu\text{s}$ $I_F = 50\text{A}; V_{GE} = 0\text{V}$		3.5		$\mu\text{C}$	
$I_{RM}$	max. reverse recovery current			40		A	
$t_{rr}$	reverse recovery time			200		ns	
$E_{rec}$	reverse recovery energy			1		mJ	
$R_{thJC}$	thermal resistance junction to case				0.66	K/W	
$R_{thCH}$	thermal resistance case to heatsink				0.66	K/W	

Package Y4				Ratings		
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$I_{RMS}$	RMS current	per terminal			300	A
$T_{VJ}$	virtual junction temperature		-40		150	°C
$T_{op}$	operation temperature		-40		125	°C
$T_{stg}$	storage temperature		-40		125	°C
<b>Weight</b>					108	g
$M_D$	mounting torque		2.25		2.75	Nm
$M_T$	terminal torque		4.5		5.5	Nm
$d_{Spp/App}$	creepage distance on surface   striking distance through air	terminal to terminal	14.0	10.0		mm
$d_{Spb/Apb}$		terminal to backside	16.0	16.0		mm
$V_{ISOL}$	isolation voltage	t = 1 second			3600	V
		t = 1 minute	50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA		3000	V



Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MID75-12A3	MID75-12A3	Box	6	474193

**Outlines Y4**



## Boost IGBT

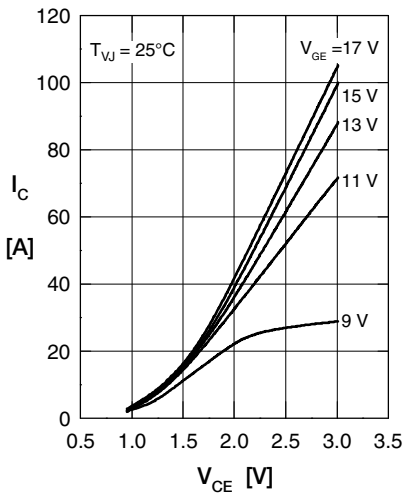


Fig. 1 Typ. output characteristics

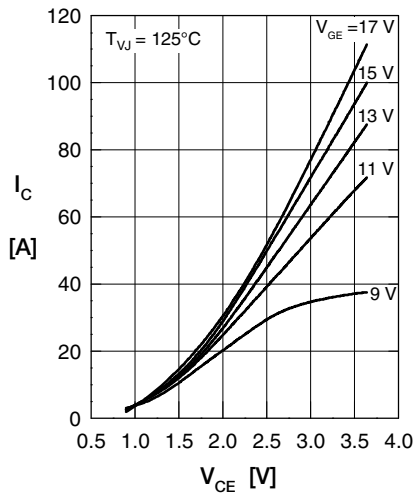


Fig. 2 Typ. output characteristics

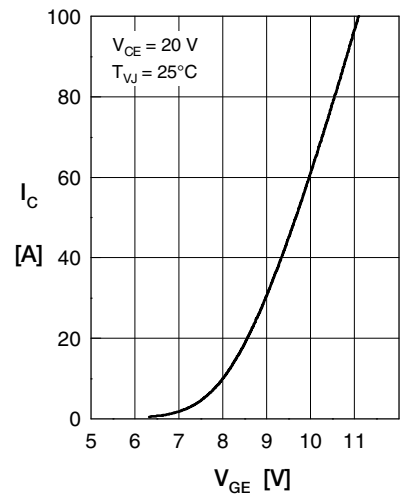


Fig. 3 Typ. transfer characteristics

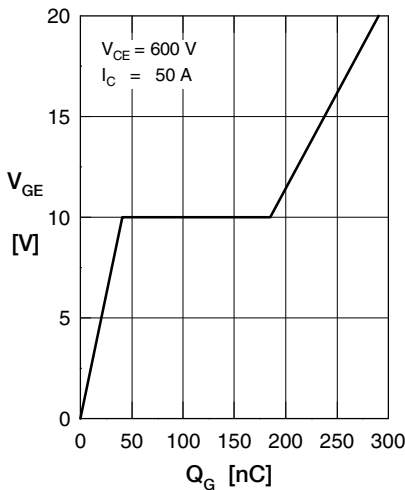


Fig. 4 Typ. turn-on gate charge

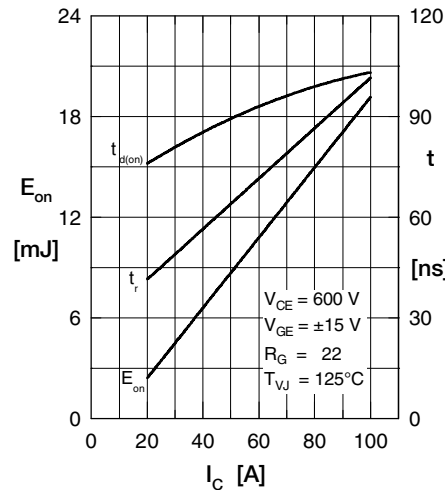


Fig. 5 Typ. turn on energy & switching times versus collector current

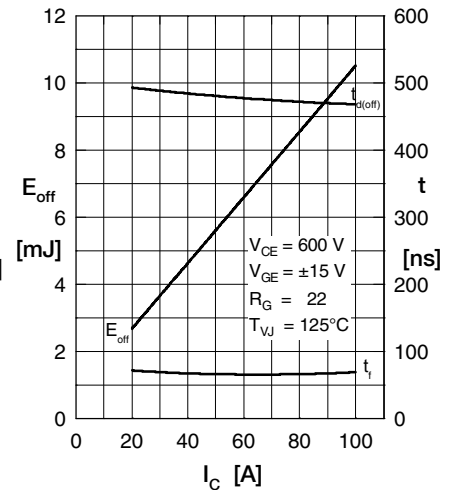


Fig. 6 Typ. turn off energy & switching times versus collector current

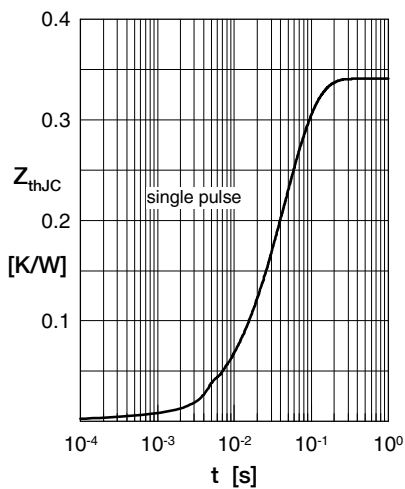


Fig. 12 Typical transient thermal impedance

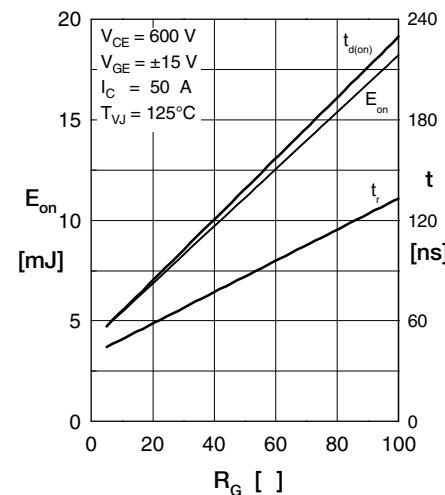


Fig. 9 Typ. turn on energy & switching times versus gate resistor

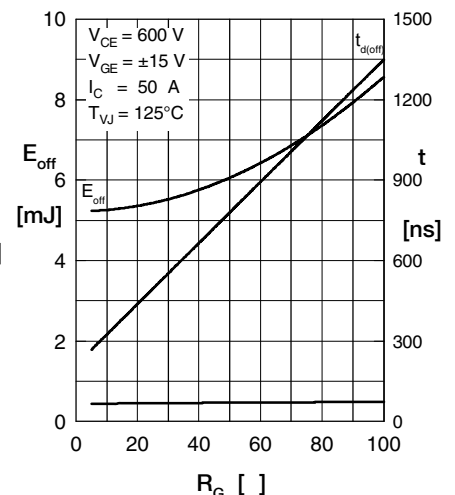


Fig. 9 Typ. turn off energy & switching times versus gate resistor

**Boost Diode BD**

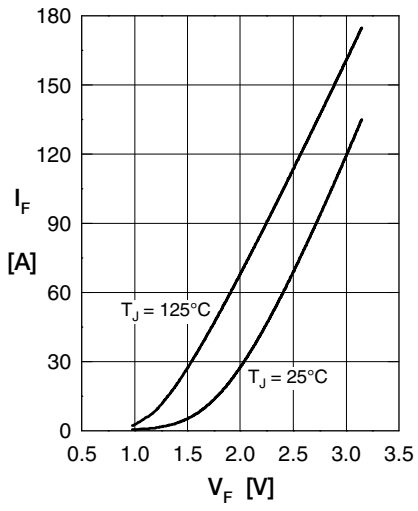


Fig. 1 Typ. Forward current vs.  $V_F$

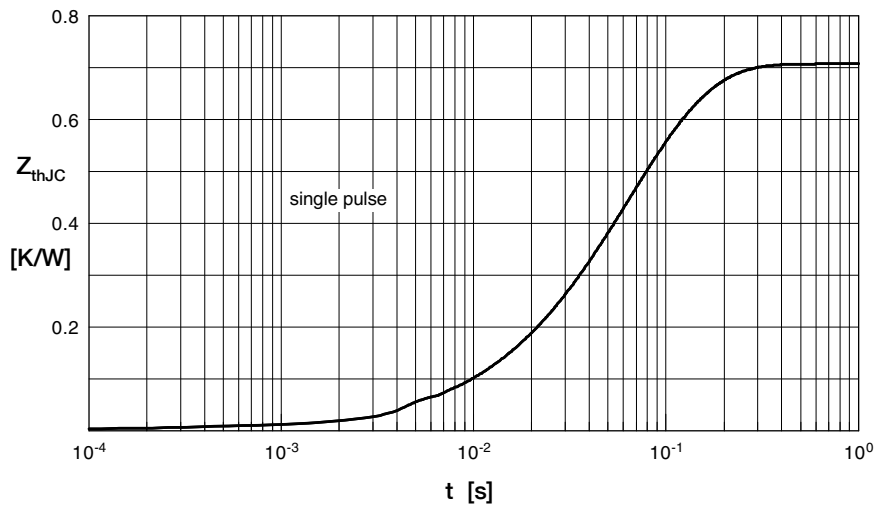


Fig. 2 Typ. transient thermal impedance junction to case

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [IGBT Modules category](#):*

*Click to view products by [IXYS manufacturer](#):*

Other Similar products are found below :

[F3L400R07ME4\\_B22](#) [F4-50R07W2H3\\_B51](#) [FB15R06W1E3](#) [FB20R06W1E3\\_B11](#) [FD1000R33HE3-K](#) [FD400R33KF2C-K](#)  
[FD401R17KF6C\\_B2](#) [FD-DF80R12W1H3\\_B52](#) [FF200R06YE3](#) [FF300R12KE4\\_E](#) [FF450R12ME4P](#) [FF600R12IP4V](#) [FP10R06W1E3\\_B11](#)  
[FP20R06W1E3](#) [FP50R12KT3](#) [FP75R07N2E4\\_B11](#) [FS10R12YE3](#) [FS150R07PE4](#) [FS150R12PT4](#) [FS200R12KT4R](#) [FS50R07N2E4\\_B11](#)  
[FZ1000R33HE3](#) [FZ1800R17KF4](#) [DD250S65K3](#) [DF1000R17IE4](#) [DF1000R17IE4D\\_B2](#) [DF1400R12IP4D](#) [DF200R12PT4\\_B6](#)  
[DF400R07PE4R\\_B6](#) [BSM75GB120DN2\\_E3223c-Se](#) [F3L300R12ME4\\_B22](#) [F3L75R07W2E3\\_B11](#) [F4-50R12KS4\\_B11](#)  
[F475R07W1H3B11ABOMA1](#) [FD1400R12IP4D](#) [FD200R12PT4\\_B6](#) [FD800R33KF2C-K](#) [FF1200R17KP4\\_B2](#) [FF300R17KE3\\_S4](#)  
[FF300R17ME4\\_B11](#) [FF401R17KF6C\\_B2](#) [FF650R17IE4D\\_B2](#) [FF900R12IP4D](#) [FF900R12IP4DV](#) [STGIF7CH60TS-L](#) [FP50R07N2E4\\_B11](#)  
[FS100R07PE4](#) [FS150R07N3E4\\_B11](#) [FS150R17N3E4](#) [FS150R17PE4](#)